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**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of: **Koji NOZAKI et al.**

Art Unit: 1795

Application Number: **10/623,679**

Examiner: **Amanda C. WALKE**

Filed: **July 22, 2003**

Confirmation Number: **5083**

For: **RESIST PATTERN THICKENING MATERIAL, RESIST PATTERN AND  
PROCESS FOR FORMING THE SAME, AND SEMICONDUCTOR DEVICE  
AND PROCESS FOR MANUFACTURING THE SAME**

Attorney Docket Number: **030891**

Customer Number: **38834**

**AMENDMENT UNDER 37 C.F.R. §1.111**

**Mail Stop Amendment**  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**March 12, 2009**

Sir:

This paper is filed in response to the Office Action dated December 12, 2008.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 12 of this paper.